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UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
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APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/062,595	01/31/2002	Harry Michael Siegel	01-C-055 (STMI01-01055)

CONFIRMATION NO. 3416

FORMALITIES LETTER



OC000000007546140

Lisa K. Jorgenson
STMICROELECTRONICS, INC.
1310 Electronics Drive
Carrollton, TX 75006

Date Mailed: 02/27/2002

NOTICE TO FILE CORRECTED APPLICATION PAPERS

Filing Date Granted

This application has been accorded an Application Number and Filing Date. The application, however, is informal since it does not comply with the regulations for the reason(s) indicated below. Applicant is given **TWO MONTHS** from the date of this Notice within which to correct the informalities indicated below. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a)

The required item(s) identified below must be timely submitted to avoid abandonment:

- Substitute drawings in compliance with 37 CFR 1.84 because:
 - drawing sheets do not have the appropriate margin(s) (see 37 CFR 1.84(g)). Each sheet must include a top margin of at least 2.5 cm. (1 inch), a left side margin of at least 2.5 cm. (1 inch), a right side margin of at least 1.5 cm. (5/8 inch), and a bottom margin of at least 1.0 cm. (3/8 inch);

*A copy of this notice **MUST** be returned with the reply.*

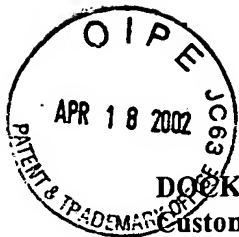
Margaret

Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 1 - ATTORNEY/APPLICANT COPY

10062595-041302



DOCKET NO. 01-C-055 (STMI01-01055)
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Harry Michael Siegel, et al.
U.S. Serial No. : 10/062,595
Filed : January 31, 2002
For : SYSTEM AND METHOD FOR ALIGNING AN INTEGRATED
CIRCUIT DIE ON AN INTEGRATED CIRCUIT SUBSTRATE
Group No. : (Not Yet Known)
Examiner : (Not Yet Assigned)

Commissioner for Patents
Washington, D.C. 20231

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

Sir:

The undersigned hereby certifies that the following documents:

1. Response to Notice to File Corrected Application Papers;
2. Five (5) sheets of formal patent drawings;
3. Copy of the Notice to File Corrected Application Papers; and
4. A postcard receipt;

relating to the above application, were deposited as "First Class Mail" with the United States Postal Service, addressed to Commissioner for Patents, Washington, D.C. 20231, on 4/8/02.

Date: 4/8/02

Mailer

Date: April 8, 2002

Kathy Lenzenecker
William A. Munck
William A. Munck
Reg. No. 39,308

P.O. Box 802432
Dallas, Texas 75380
Phone: (214) 922-9221
Fax: (214) 969-7557
E-mail: wmunck@davismunck.com



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DOCKET NO. 01-C-055 (STMI01-01055)
Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Harry Michael Siegel, et al.
U.S. Serial No. : 10/062,595
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Group No. : (Not Yet Known)
Examiner : (Not Yet Assigned)

Commissioner for Patents
Washington, D. C. 20231

Sir:

RESPONSE TO NOTICE TO FILE CORRECTED APPLICATION PAPERS

In response to the Notice to File Missing Parts of Application dated February 27, 2002, attached are the following documents:

1. Five (5) sheets of formal patent drawings;
2. A copy of the Notice to File Missing Parts of Application; and
3. Our postcard receipt.

The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-0208.

Respectfully submitted,

DAVIS MUNCK, P.C.

Date: April 8, 2002

William A. Munck
William A. Munck
Registration No. 39,308

P.O. Box 802432
Dallas, Texas 75380
Phone: (214) 922-9221
Fax: (214) 969-7557
email: wmunck@davismunck.com

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